

2. (twice amended). The heat-sealable composite film of Claim 31 wherein the MFR of said outer ply (b) is 0.1 to 3 g/10min.

3. (twice Amended, Clean). The heat-sealable composite film of Claim 31 wherein the MFR of said outer ply (b) is 0.5 to 2 g/10 min.

4. (twice amended) The heat-sealable composite film of Claim 31 wherein the MFR of said inner play (i) is at least twice the MFR of said outer ply (b).

5. (twice amended). The heat-sealable film of Claim 31 wherein the MFR of said inner ply (i) is at least thrice the MFR of said outer play (b).

6. (twice amended). The heat-sealable composite film of Claim 31 wherein the weight per area of said inner ply (i) is at least 60% of the weight per area of said multi-ply laminate (l).

7. (twice amended). The heat-sealable composite film of Claim 31 wherein the weight per area of said inner ply (i) is at least 70% of the weight per area of said multi-ply laminate (l).

8. (twice amended). The heat-sealable composite film of Claim 31 wherein said outer ply (b) has a thickness of 5 to 50 μm .

9. (twice amended). The heat-sealable composite film of Claim 31 wherein said

outer ply (b) has a thickness of 10 to 30 μm .

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Coat 10. (twice amended). The heat-sealable composite film of Claim 31 wherein said outer ply (b) has a thickness of 10 to 20 μm .

12. (twice amended). The heat-sealable composite film of Claim 31 wherein said inner ply (i) includes two piles.

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Coat 13. (three times amended). The heat-sealable composite film of Claim 31 wherein said outer ply polymeric resin comprises at least one member selected from the group consisting of ethylene/vinyl acetate copolymer, ethylene/unsaturated ester copolymer, ethylene/unsaturated carboxylic acid copolymer, salt of ethylene/unsaturated carboxylic acid copolymer, low density polyethylene, high density polyethylene, and copolymer of ethylene and α -olefin having at least 3 carbon atoms.

14. (amended). The heat-sealable composite film of claim 13 wherein said unsaturated ester comprises at least one member selected from the group consisting of butyl acrylate and ethyl acrylate.

E3 15. (amended). The heat-sealable composite film of claim 13 wherein α -olefin of said copolymer of ethylene comprises at least one member selected from the group consisting of butane, hexane, octane and 4-methyl-1-pentene.

16. (amended). The heat-sealable composite film of Claim 15 wherein copolymer

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Cant comprises the product of a reaction catalyzed by metallocene.

24 17. (twice amended). The heat-sealable composite film of Claim 31 wherein said inner ply polymeric resin comprises at least one member selected from the group consisting of ethylene/vinyl acetate copolymer, ethylene/unsaturated ester copolymer, ethylene unsaturated carboxylic acid copolymer, salt of ethylene/unsaturated carboxylic acid copolymer, low density polyethylene, high density polyethylene, and copolymer of ethylene and α -olefin having at least 3 carbon atoms.

55 18. (three times amended). The heat-sealable composite film of Claim 31 wherein said outer ply polymeric resin comprises at least one member selected from the group consisting of ethylene/vinyl acetate copolymer wherein content of vinyl acetate is at most 20% relative to the weight of said copolymer; ethylene/unsaturated carboxylic acid copolymer wherein content of carboxylic acid is at most 8% relative to the weight of said copolymer; salt of ethylene/unsaturated carboxylic acid copolymer having a content of carboxylic acid of at most 10% relative to the weight of said copolymer; low density polyethylene having a density of 0.91 to 0.935 g/cm³; and copolymer of ethylene and α -olefin having density of 0.90 to 0.94 g/cm³.

19. (three times amended). The heat-sealable composite film of Claim 31 wherein said inner ply polymeric resin comprises at least one member selected from the group consisting of: ethylene/vinyl acetate copolymer wherein content of vinyl acetate is at most 20% relative to the weight of said copolymer; ethylene/unsaturated carboxylic acid copolymer wherein content of carboxylic acid is at most 8% relative to the weight of said

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copolymer; salt of ethyl ne/unsaturated carboxylic acid copolymer having a content of carboxylic acid of at most 10% relative to the weight of said copolymer; low density polyethylene having a density of 0.91 to 0.935 g/cm³; and copolymer of ethylene and α -olefin having density of 0.90 to 0.94 g/cm³.

20. (twice amended) The heat-sealable composite film of Claim 31 wherein said outer ply (b) comprises a copolymer of ethylene and α -olefin.

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21. (twice amended) The heat-sealable composite film of Claim 20 wherein said copolymer further comprises at least one member selected from the group consisting of low density polyethylene and copolymer of ethylene and vinyl acetate, said member being present in an amount of up to 50% relative to the total weight of said ply (b).

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22. (amended) The heat-sealable composite film of Claim 21 wherein said copolymer of ethylene and α -olefin is characterized in that it is a product of a reaction catalyzed by metallocene, and in that it has a crystalline melting point of at most 110°C, and in that its ratio of weight average molecular weight to number average molecular weight is at most 3.

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23. (twice amended) The heat-sealable composite film of Claim 31 wherein at least one of said inner ply (i) and said outer ply (b) include at least one of anti-blocking additives and dyes.

24. (twice amended) The heat-sealable composite film of Claim 31 wherein said

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outer ply (b) comprises 0.1 to 2% relative to the weight of said outer ply (b) of solid inorganic particles selected from the group consisting of silicon oxide, calcium carbonate, magnesium silicate, aluminum silicate, calcium phosphate and talc.

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26. (four-times amended). The heat-sealed composite film of claim 31, wherein said substrate is selected from the group consisting of metal, cardboard, paper, paperboard, textile, non-woven fabric, plastic and composites thereof, said plastic being other than said outer ply polymer resin and said inner ply polymer resin.

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30. (twice amended) A composite film comprising the multi-ply heat-sealable layer of Claim 31 with said outer ply (b) being one outer ply of said multi-ply heat-sealable layer.

31. (twice amended). A heat-sealable composite film comprising a multi-ply heat-sealable layer (I) and a substrate, said multi -ply heat-sealable layer (I) consisting of:

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an outer ply (b) having a melt flow rate (MFR), as determined in accordance with DIN ISO 1133 at 190°C and 2.16 kg, of at least 0.1 g/10 min., and comprising an outer ply polymeric resin; and

at least one inner ply (i), each inner ply (i) having an MFR, as determined in accordance with DIN ISO 1133 at 190°C and 2.16 kg, that is greater than the MFR of said outer ply (b), and comprising an inner ply polymeric resin, said at least one inner ply (i) being between said outer ply (b) and said substrate
wherein the weight per unit area of said inner ply (i) is at least 40% of the weight per unit area of said multi-ply laminate (I).
